

L Number	Hits	Search Text	DB	Time stamp
1	929	(425/192R).CCLS.	USPAT	2003/05/14 13:59
2	2	425/182-196.ccls. and (lock or locking) and ((nozzle) with (heater or substrate))	USPAT; US-PGPUB	2003/05/14 14:03
3	37	425/182-196.ccls. and ((nozzle) with (heater or substrate))	USPAT; US-PGPUB	2003/05/14 14:04
-	871	((425/547) or (425/549)).CCLS.	USPAT	2003/05/14 12:57
-	130	(425/DIG.13).CCLS.	USPAT	2002/04/02 12:57
-	258	(264/328.15).CCLS.	USPAT	2002/04/02 13:49
-	864	heater and resist\$ and conduct\$ and insulat\$ and mold and injection	USPAT	2002/04/02 13:55
-	19	heater and resistive and conductive and insulative and mold and injection	USPAT	2002/04/02 13:57
-	0	DE19941038A1	DERWENT	2002/04/02 14:12
-	0	DE019941038A1	DERWENT	2002/04/02 14:13
-	0	Gunther.inv. and Otschik.inv. and Kretschmar.inv.	DERWENT	2002/04/02 14:13
-	0	Gunther.inv.	DERWENT	2002/04/02 14:14
-	12	Olbricht	DERWENT	2002/04/02 14:14
-	2592	(silk adj2 screen\$2) and layer and substrate	USPAT; US-PGPUB	2002/04/08 08:20
-	259	(silk adj2 screen\$2) and (425/\$.ccls. or 264/\$.ccls.)	USPAT; US-PGPUB	2002/04/08 11:35
-	1	425/\$.ccls. and (resistive adj trace)	USPAT; US-PGPUB	2002/04/08 11:35
-	0	layer and (resistive adj trace) and (low adj resistance adj conductive)	USPAT; US-PGPUB	2002/04/19 12:44
-	60	layer and (resistive) and (low adj resistance adj conductive)	USPAT; US-PGPUB	2002/04/19 13:24
-	0	425/\$.ccls. and nozzle and (housing with (locating adj2 hole))	USPAT; US-PGPUB	2002/04/19 14:11
-	0	425/\$.ccls. and nozzle and (housing with (locking adj2 detent))	USPAT; US-PGPUB	2002/04/19 13:33
-	0	425/\$.ccls. and nozzle and (heater with (locking adj2 detent))	USPAT; US-PGPUB	2002/04/19 13:36
-	0	425/\$.ccls. and nozzle and (heater with (locating adj2 hole))	USPAT; US-PGPUB	2002/04/19 13:36
-	1	(resistive adj layer) with (photoforming or ((abrasive or laser) adj etching))	USPAT; US-PGPUB	2002/04/19 14:41
-	1	(resistive adj layer) and (photoforming)	USPAT; US-PGPUB	2002/04/19 14:55
-	30	photoforming with layer	USPAT; US-PGPUB	2002/04/19 15:36
-	1	("1500 VAC" or "1000 VAC") and (insulation with ("100" near2 ohms))	USPAT; US-PGPUB	2002/04/19 15:51
-	1	"resistive trace" and (low with resistance with conductive with trace)	USPAT; US-PGPUB	2002/04/21 16:37
-	3	"resistive trace" and (low with resistance with conductive)	USPAT; US-PGPUB	2002/04/19 15:59
-	0	detent and locking and hole and connector and housing and 425/\$.ccls. and heater and nozzle	USPAT; US-PGPUB	2002/04/21 16:39
-	467	housing and 425/\$.ccls. and heater and nozzle	USPAT; US-PGPUB	2002/04/21 16:48
-	0	(detent and locking and hole and connector and housing and 425/\$.ccls. and heater and nozzle) and (nozzle with heater) and dielectric	USPAT; US-PGPUB	2002/04/21 16:49
-	3	(housing and 425/\$.ccls. and heater and nozzle) and (nozzle with heater) and dielectric	USPAT; US-PGPUB	2002/04/21 16:53
-	545	((425/185) or (425/186)).CCLS.	USPAT	2003/05/14 12:58